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April 2015

# 74LCX157 Low Voltage Quad 2-Input Multiplexer with 5 V Tolerant Inputs

### **Features**

- 5 V Tolerant Inputs
- 2.3 V 3.6 V, V<sub>CC</sub> Specifications Provided
- 5.8 ns  $t_{PD}$  max. ( $V_{CC} = 3.3 \text{ V}$ ), 10  $\mu$ A  $I_{CC}$  max.
- Power Down High Impedance Inputs and Outputs
- ±24 mA Output Drive (V<sub>CC</sub> = 3.0 V)
- · Implements Patented Noise/EMI Reduction Circuitry
- Latch-Up Performance Exceeds 500 mA
- ESD Performance:

Human Body Model > 2000 V Machine Model > 200 V

# **General Description**

The LCX157 is a high-speed quad 2-input multiplexer. Four bits of data from two sources can be selected using the common Select and Enable inputs. The four outputs present the selected data in the true (noninverted) form.

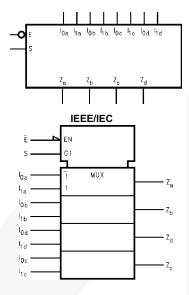
The LCX157 can also be used as a function generator.

The 74LCX157 is fabricated with advanced CMOS technology to achieve high speed operation while maintaining CMOS low power dissipation.

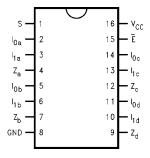
# **Ordering Information**

Part Number	Top Mark	Package	Packing Method
74LCX157M	LCX157	SOIC 16L	Rail
74LCX157MX	LCX157	SOIC 16L	Tape and Reel
74LCX157MTC	LCX157	TSSOP 16L	Rail
74LCX157MTCX	LCX157	TSSOP 16L	Tape and Reel

# **Logic Symbols**



# **Connection Diagram**



# **Pin Descriptions**

Pin Names	Description	
I <sub>0a</sub> –I <sub>0d</sub>	Source 0 Data Inputs	
I <sub>1a</sub> –I <sub>1d</sub>	Source 1 Data Inputs	
Ē	Enable Input	
S	Select Input	
$Z_a$ – $Z_d$	Outputs	

# **Functional Description**

The LCX157 is a quad 2-input multiplexer. It selects four bits of data from two sources under the control of a common Select input (S). The Enable input ( $\overline{E}$ ) is active-LOW. When  $\overline{E}$  is HIGH, all of the outputs (Z) are forced LOW regardless of all other inputs. The LCX157 is the logic implementation of a 4-pole, 2-position switch where the position of the switch is determined by the logic levels supplied to the Select input. The logic equations for the outputs are shown below:

$$Z_{a} = \overline{E} \cdot (I_{1a} \cdot S + I_{0a} \cdot \overline{S})$$

$$Z_{b} = \overline{E} \cdot (I_{1b} \cdot S + I_{0b} \cdot \overline{S})$$

$$Z_{c} = \overline{E} \cdot (I_{1c} \cdot S + I_{0c} \cdot \overline{S})$$

$$Z_{d} = \overline{E} \cdot (I_{1d} \cdot S + I_{0d} \cdot \overline{S})$$

A common use of the LCX157 is the moving of data from two groups of registers to four common output busses. The particular register from which the data comes is determined by the state of the Select input. A less obvious use is as a function generator. The LCX157 can generate any four of the sixteen different functions of two variables with one variable common. This is useful for implementing gating functions.

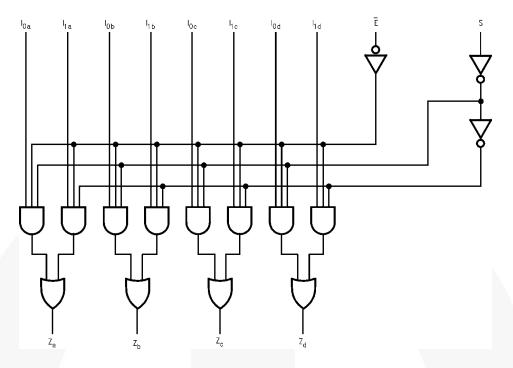
# **Truth Table**

	Inputs			Outputs
Ē	s	I <sub>0</sub>	I <sub>1</sub>	Z
Н	Х	Х	Х	L
L	Н	X	L	L
L	Н	X	Н	Н
L	L	L	Х	L
L	L	Н	Х	Н

H = HIGH Voltage Level L = LOW Voltage Level

X = Immaterial

# Logic Diagram<sup>(1)</sup>



### Note:

1. Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

# Absolute Maximum Ratings(2)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Value	Conditions	Unit
V <sub>CC</sub>	Supply Voltage	-0.5 to +7.0		V
V <sub>I</sub>	DC Input Voltage	-0.5 to +7.0		V
Vo	DC Output Voltage	-0.5 to V <sub>CC</sub> +0.5	Output in HIGH or LOW State <sup>(3)</sup>	V
I <sub>IK</sub>	DC Input Diode Current	-50	V <sub>I</sub> < GND	mA
1 2	DC Output Diode Current	-50	V <sub>O</sub> < GND	mA
I <sub>OK</sub>	DC Output Diode Current	+50	$V_O > V_{CC}$	ША
Io	DC Output Source/Sink Current	±50		mA
I <sub>cc</sub>	DC Supply Current per Supply Pin	±100		mA
I <sub>GND</sub>	DC Ground Current per Ground Pin	±100		mA
T <sub>STG</sub>	Storage Temperature	-65 to +150		°C

### Notes:

- 2. The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.
- 3. IO Absolute Maximum Rating must be observed.

# **Recommended Operating Conditions**(4)

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Unit	
V <sub>CC</sub>	Supply Voltage	Operating	2.0	3.6	V
V <sub>IN</sub>	Input Voltage		0	5.5	V
V <sub>OUT</sub>	Output Voltage	HIGH or LOW State	0	V <sub>CC</sub>	V
		$V_{CC} = 3.0 \text{ V} - 3.6 \text{ V}$		±24	
I <sub>OH</sub> /I <sub>OL</sub>	Output Current	$V_{CC} = 2.7 \text{ V} - 3.0 \text{ V}$		±12	mA
		$V_{CC} = 2.3 \text{ V} - 2.7 \text{ V}$		±8	
T <sub>A</sub>	Free-Air Operating Temperature		-40	85	°C
Δt/ΔV	Input Edge Rate, V <sub>IN</sub> = 0.8 V - 2.0 V, V <sub>CC</sub> = 3.0 V		0	10	ns/V

### Note:

4. Unused inputs must be held HIGH or LOW. They may not float.

# **DC Electrical Characteristics**

Symbol	Parameter	Conditions	V (V)	$T_A = -40 \text{ to } +85^{\circ}\text{C}$		Unit	
Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Min.	Max.	Oilit	
V	1110111		2.3 - 2.7	1.7		V	
V <sub>IH</sub>	HIGH Level Input Voltage		2.7 - 3.6	2.0		_ v	
V	LOW Level level Veltage		2.3 - 2.7	1	0.7	V	
V <sub>IL</sub>	LOW Level Input Voltage		2.7 - 3.6		8.0	V	
		I <sub>OH</sub> = -100 μA	2.3 - 3.6	V <sub>CC</sub> - 0.2			
		$I_{OH} = -8 \text{ mA}$	2.3	1.8			
$V_{OH}$	HIGH Level Output Voltage	I <sub>OH</sub> = -12 mA	2.7	2.2		V	
		I <sub>OH</sub> = -18 mA	3.0	2.4			
		I <sub>OH</sub> = -24 mA	3.0	2.2		/	
		I <sub>OL</sub> = 100 μA	2.3 - 3.6		0.2		
		I <sub>OL</sub> = 8 mA	2.3		0.6		
V <sub>OL</sub>	LOW Level Output Voltage	I <sub>OL</sub> = 12 mA	2.7		0.4	V	
		I <sub>OL</sub> = 16 mA	3.0		0.4		
		I <sub>OL</sub> = 24 mA	3.0		0.55		
I <sub>I</sub>	Input Leakage Current	$0 \le V_1 \le 5.5 \text{ V}$	2.3 - 3.6		±5.0	μΑ	
I <sub>OFF</sub>	Power-Off Leakage Current	$V_I$ or $V_O = 5.5 \text{ V}$	0		10	μΑ	
1		$V_I = V_{CC}$ or GND	2.3 - 3.6		10		
I <sub>CC</sub> Qu	Quiescent Supply Current	$3.6 \text{ V} \le \text{V}_{\text{I}} \le 5.5 \text{ V}$	2.3 - 3.6		±10	μΑ	
Δl <sub>CC</sub>	Increase in I <sub>CC</sub> per Input	V <sub>IH</sub> = V <sub>CC</sub> - 0.6 V	2.3 - 3.6		500	μΑ	

# **AC Electrical Characteristics**

		$T_A = -40 \text{ to } +85^{\circ}\text{C}, R_L = 500 \Omega$						
Symbol	Parameter	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ $C_L = 50 \text{ pF}$		V <sub>CC</sub> = 2.7 V C <sub>L</sub> = 50 pF		$V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ $C_L = 30 \text{ pF}$		Unit
Symbol	Parameter							
		Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>PHL</sub>	Propagation Delay	1.5	7.0	1.5	8.0	1.5	8.4	ns
t <sub>PLH</sub>	$S \rightarrow Z_n$	1.5	7.0	1.5	8.0	1.5	8.4	115
t <sub>PHL</sub>	Propagation Delay	1.5	7.0	1.5	8.0	1.5	8.4	ns
t <sub>PLH</sub>	$\overline{E} \rightarrow Z_n$	1.5	7.0	1.5	8.0	1.5	8.4	115
t <sub>PHL</sub>	Propagation Delay	1.5	5.8	1.5	6.3	1.5	7.0	ns
t <sub>PLH</sub>	$I_n \rightarrow Z_n$	1.5	5.8	1.5	6.3	1.5	7.0	115
t <sub>OSHL</sub>	(5)		1.0					nc
toslh	Output to Output Skew <sup>(5)</sup>		1.0					ns

### Note:

5. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW ( $t_{OSHL}$ ) or LOW-to-HIGH ( $t_{OSLH}$ ). Parameter guaranteed by design.

# **Dynamic Switching Characteristics**

Symbol	Parameter	Conditions	V (\( \)	T <sub>A</sub> = 25°C	Unit
Symbol	Faranietei	Conditions	V <sub>CC</sub> (V)	Typical	Onit
V	Quiet Output Dynamic Peak V <sub>OL</sub>	$C_L = 50 \text{ pF}, V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V
V <sub>OLP</sub>	Quiet Output Dynamic Feak V <sub>OL</sub>	$C_L = 30 \text{ pF}, V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$	2.5	0.6	V
V	Quiet Output Dynamic Valley V <sub>OL</sub>	$C_L = 50 \text{ pF}, V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	-0.8	V
V <sub>OLV</sub> Quiet Output Dynamic Valley \		$C_L = 30 \text{ pF}, V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$	2.5	-0.6	V

# Capacitance

Symbol	Parameter	Conditions	Typical	Unit
C <sub>IN</sub>	Input Capacitance	$V_{CC}$ = Open, $V_I$ = 0 V or $V_{CC}$	7	pF
C <sub>OUT</sub>	Output Capacitance	$V_{CC} = 3.3 \text{ V}, V_{I} = 0 \text{ V or } V_{CC}$	8	pF
C <sub>PD</sub>	Power Dissipation Capacitance	$V_{CC}$ = 3.3 V, $V_{I}$ = 0 V or $V_{CC}$ , f = 10 MHz	25	pF

# AC Loading and Waveforms Generic for LCX Family

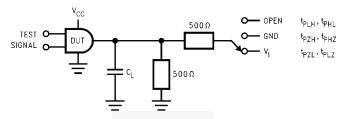
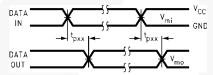
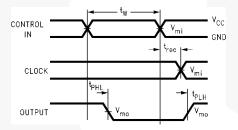


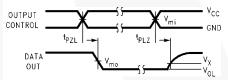
Figure 1. AC Test Circuit (C<sub>L</sub> includes probe and jig capacitance)

Test	Switch
t <sub>PLH</sub> , t <sub>PHL</sub>	Open
t <sub>PZL</sub> , t <sub>PLZ</sub>	6V at $V_{CC}$ = 3.3 $\pm$ 0.3V $V_{CC}$ x 2 at $V_{CC}$ = 2.5 $\pm$ 0.2V
t <sub>PZH</sub> , t <sub>PHZ</sub>	GND

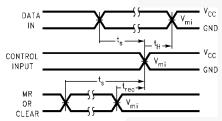


# **Waveform for Inverting and Non-Inverting Functions**



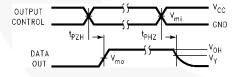


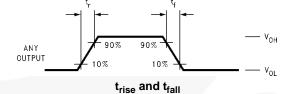
3-STATE Output Low Enable and Disable Times for Logic



Propagation Delay. Pulse Width and t<sub>rec</sub> Waveforms

Setup Time, Hold Time and Recovery Time for Logic



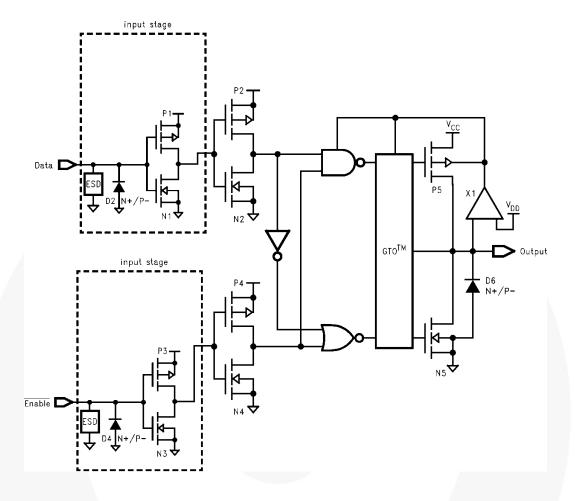


3-STATE Output High Enable and Disable Times for Logic

Figure 2. Waveforms (Input Characteristics; f = 1 MHz,  $t_r = t_f = 3$  ns)

Symbol		V <sub>CC</sub>	
Syllibol	$\textbf{3.3V} \pm \textbf{0.3V}$	2.7V	$\textbf{2.5V} \pm \textbf{0.2V}$
$V_{mi}$	1.5V	1.5V	V <sub>CC</sub> /2
$V_{mo}$	1.5V	1.5V	V <sub>CC</sub> /2
V <sub>x</sub>	V <sub>OL</sub> + 0.3V	V <sub>OL</sub> + 0.3V	V <sub>OL</sub> + 0.15V
V <sub>y</sub>	V <sub>OH</sub> – 0.3V	V <sub>OH</sub> – 0.3V	V <sub>OH</sub> – 0.15V

# Schematic Diagram Generic for LCX Family



# **Physical Dimensions** 10.00 9.80 8.89 В 4.00 3.80 6.00 5.6 **PIN ONE INDICATOR** 1.27 (0.30)**⊕** 0.25 **M** C B A LAND PATTERN RECOMMENDATION 1.75 MAX SEE DETAIL A 1.50 1.25 0.25 \_0.25 0.19 0.50 X 45° NOTES: UNLESS OTHERWISE SPECIFIED (R0.10) A) THIS PACKAGE CONFORMS TO JEDEC MS-012, VARIATION AC, ISSUE C. B) ALL DIMENSIONS ARE IN MILLIMETERS. C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS D) CONFORMS TO ASME Y14.5M-1994 E) LANDPATTERN STANDARD: SOIC127P600X175-16AM F) DRAWING FILE NAME: M16AREV12. **GAGE PLANE** (R0.10) 0.36 **SEATING PLANE** 0.90 0.50 (1.04) -**DETAIL A**

Figure 3. 16-LEAD, SOIC, JEDEC MS-012, 0.150 INCH, NARROW BODY

# Α 5.00±0.10 4.55 5.90 4.45 7.35 B 6.4 0.65 4.4±0.1 3.2 O.2 CBA ALL LEAD TIPS 5.00 PIN #1 IDENT. LAND PATTERN RECOMMENDATION (F) 0.11 SEE DETAIL A ALL LEAD TIPS 1.1 MAX (0.90)◯ 0.1 C -C-0.10±0.05 0.65 0.19 - 0.30 TOP AND BOTTOM **♦ 0.10** A B C C S GAGE PLANE NOTES: 0.25 A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB, B. DIMENSIONS ARE IN MILLIMETERS C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS 0.6±0.1 SEATING PLANE D. DIMENSIONING AND TOLERANCES PER ANSI Y14.5M, 1994 E. DRAWING FILE NAME: MTC16REV4 **DETAIL** A F. LAND PATTERN RECOMMENDATION PER IPC7351 - ID# TSOP65P640X110-16N

Figure 4. 16-LEAD, TSSOP, JEDEC MO-153, 4.4 MM WIDE

MTC16rev4

Physical Dimensions (Continued)





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Definition of Terms	ennition of Terms			
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